

Electronic Acknowledgement Receipt

EFS ID:	3226957
Application Number:	10550645
International Application Number:	
Confirmation Number:	1944
Title of Invention:	Semiconductor device and method for manufacturing the same
First Named Inventor/Applicant Name:	Tominaga Koji
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Filer:	Daniel P. Lent
Filer Authorized By:	
Attorney Docket Number:	FUJ-0002
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	FUJ_0002_Amendment.pdf	29564 d152b7093cd56af61a3c3ec93e8b2a61ae608a67	no	7

Warnings:

Information:

2	Information Disclosure Statement (IDS) Filed	FUJ_0002_US_IDS_Form_SB_08a.pdf	749664 25e5b8ae665790f29a249e5a8c15f2ebcd507db3	no	4
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3	NPL Documents	KR_Notification_of_Rejection_reason.pdf	415569 1a5adefef1fd761410b1cf3d6d75fe30460a86b	no	5
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4	Fee Worksheet (PTO-06)	fee-info.pdf	8328 4a7d6b3b2f0893cfddcbef11dea506137478b8c	no	2
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